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# Scaling Analysis of SiO<sub>2</sub>/Si Interface Roughness by Atomic Force Microscopy

Tatsuo YOSHINOBU, Atsushi IWAMOTO and Hiroshi IWASAKI

The Institute of Scientific and Industrial Research, Osaka University, 8-1 Mihogaoka, Ibaraki, Osaka 567, Japan.

The scaling behavior of  $SiO_2/Si$  interface roughness was investigated by atomic force microscopy. The rms value of the roughness increased as a power of the scale up to 100nm with the scaling exponent of 0.3 - 0.5, and saturated at *ca*. 0.3nm above 100nm scale. The scaling behavior of the observed roughness was well described by an exponential autocorrelation function with the correlation length of *ca*. 15nm. The relevancy of the scaling behavior to MOSFET channel carrier mobility is discussed.

# 1. INTRODUCTION

With the development of integrated circuit technology, a precise control of surfaces and interaces is getting more and more significant in fabrication of a submicron device, since the influence of roughness in such a small system might be crucial to the device performance. For example, it is known that the electron mobility in a metaloxide-semiconductor (MOS) system is seriously affected by scattering due to the roughness of the SiO<sub>2</sub>/Si interface.<sup>1,2)</sup> Therefore, a quantitative characterization of roughness is required in evaluation of processes.

As a measure of surface roughness, the rms value has been conventionally employed in engineering. It is often overlooked, however, that the rms value is well-defined only at a macroscopic scale. The scaling behavior of roughness must be taken into account at a mesoscopic scale, where the fractal nature of the surface is noticable.<sup>3-6)</sup>

In this study, the  $SiO_2/Si$  interface is investigated by AFM to reveal the scaling behavior of roughness.

### 2. EXPERIMENTS

Specimens were prepared as follows. A p-type Si(100) wafer (p=10 $\Omega$ cm) was cleand in the RCA process, and the chemical oxide was etched off in 1% HF. Dry oxidation was performed at 900°C followed by 15min of annealing in N<sub>2</sub> at 900°C. The thickness of the

oxide was 16.0nm. Specimens were dipped in 5% HF for oxide removal just before the AFM measurment in air.

In order to investigate the scaling behavior, AFM measurements were carried out for various sizes of areas, *i.e.*,  $100 \times 100 \text{nm}^2$ ,  $800 \times 800 \text{nm}^2$ ,  $5 \times 5 \mu \text{m}^2$  and  $20 \times 20 \mu \text{m}^2$ . In each measurement, the height data were acquired at 256 × 256 pixels. The AFM instrument employed in this study is a SFA-300/SPI-3600 from Seiko Instruments Inc.

#### 3. RESULTS AND DISCUSSION

To investigate the geometrical properties of the SiO<sub>2</sub>/Si interface, several statistical quantities were extracted from the AFM images.

## Width of interface

The width of interface W(L) is defined as the rms value of roughness calculated in a square of size LxL.<sup>4)</sup> The procedure of calculation is as follows. For each AFM image, the linear trend in the height data (or the sample mounting error) is removed, and then the image is divided into  $2^n \times 2^n$  sections. The rms value is calculated in each section, and is averaged over all sections. In this way, a series of W(L) are calculated from an AFM image. Those series of values calculated from several different sizes of images are connected together so that they cover a wide range of scales.

Figure 1 shows the width of SiO<sub>2</sub>/Si

interface calculated from AFM images as a function of the scale. Two distinct regions with different scaling behaviors are clearly observed. At scales larger than 100nm, the width is constant at ca. 0.3nm, which corresponds to the conventional rms value. At scales smaller than 100nm, the width varies as a power of the scale with the scaling exponent of 0.3 - 0.5, *i.e.*,

 $W(L) = L^{\alpha}$  ( $\alpha = 0.3 - 0.5$ ). (1) In this region, the geometry is identified as *self-affine*<sup>5)</sup> in the sense that the roughness scales anisotropically in horizontal and vertical directions.

Qualitatively, the scaling behavior described above is in good agreement with the theory of kinetic roughening of a growing interface under far-fromequilibrium conditions.<sup>4)</sup>



Fig.1 Width of SiO<sub>2</sub>/Si interface vs. scale.

#### Autocorrelation function

The autocorrelation function is defined as

 $ACF(\mathbf{r}) = \langle \widehat{\mathbf{h}}(\mathbf{r}_0) \cdot \widehat{\mathbf{h}}(\mathbf{r}_0 + \mathbf{r}) \rangle, \qquad (2)$ 

where

 $h(r) = h(r) - \langle h(r) \rangle$ 

is the height relative to the average plane at position r.

The autocorrelation function has been conventionally assumed to be Gaussian, *i.e.*,

$$ACF(r) = \Delta^2 \cdot \exp(-r^2/L_c^2), \qquad (4)$$

in theoretical estimation of the surface roughness scattering of electrons at a  $SiO_2/Si$  interface.<sup>1,2)</sup> On the other hand, recent experiments show that the exponential autocorrelation

$$\Delta CF(r) = \Delta^2 \cdot \exp(-r/L_c), \tag{5}$$

gives a better fit of data rather than the Gaussian autocorrelation.<sup>7,8)</sup> As for the value of the correlation length  $L_c$ , however, there is still a large discrepancy between experiments.<sup>7-9)</sup>

We consider such a discrepancy comes from the scaling behavior of the

interface roughness itself. It is obvious from Fig.1 that low-frequency components of roughness are cut off in observation of a small area. Goodnick et al. <sup>7)</sup> were aware of the effect of finite picture-length (typically, 40 -80nm) in TEM observations, and Khaikin et al. <sup>10)</sup> pointed out the existance of low-frequency components with a length of 30 - 60nm, based on the spectrum analysis of STM images.

Figure 2 shows the autocorrelation functions calculated from AFM images of different sizes. As is expected, the correlation length seems to be much smaller in a smaller image. Therefore, it is important to determine the roughness parameters by fitting to the autocorrelation function for the relevant length scale: e.g., the electron mean free path in the case of roughness scattering.



Fig.2 Autocorrelation functions calculated from AFM images of different sizes.

## Power spectral density

The (one-dimensional) power spectral density can be obtained by calculating the Fourier transform of the autocorrelation function. Several AFM images of different sizes cover a wide range of spatial frequencies.

Figure 3 shows the power spectral density vs. spatial frequency. At frequencies higher than  $10^{-2}$ nm<sup>-1</sup>, the power spectral density is dependent on the spatial frequency with a slope of ca. -2, which is a very commonly observed value for fractal surfaces.<sup>31</sup> At frequencies lower than  $10^{-2}$ nm<sup>-1</sup>, the power spectral density is almost constant.

The Fourier transform of the autocorrelation function (5) gives

$$PSD(f) = \frac{2\Delta^2 L_c}{(2\pi f L_c)^2 + 1},$$
(6)

which behaves as

(3)

$$PSD(f) \propto const. \quad for \ f << (2\pi L_c)^{-1}, \tag{7}$$

 $f^{-2}$  for  $f >> (2\pi L_c)^{-1}$ , reement with our overal

in agreement with our overal PSD(f) results. The flection point of  $10^{-2}$ nm<sup>-1</sup> in Fig.3 gives a correlation length L<sub>c</sub> of *ca*. 15nm.

The rms roughness  $\Delta$  and PSD(f) has the relation

$$\Delta^2 = \int_{-\infty}^{+\infty} \text{PSD}(f) df.$$
(8)

Therefore, the measurement of  $\Delta$  must be carried out on a scale at least larger than the correlation length, otherwise it is underestimated due to low-frequency cut-off of PSD(f).



Fig.3 Power spectral density of  $SiO_2/Si$  interface roughness vs. spatial frequency.

## Comparison with simulation

As described in the previous section, the observed power spectral density is in good agreement with the exponential autocorrelation function. In the case of the Gaussian autocorrelation function, the power spectral density falls much faster at higher frequencies.

Another comparison was made by calculating the width of interface from the roughness generated by computer simulation. The method of simulation is the same as described in Ref.6. The roughness parameters used here are  $\Delta = 0.3$ nm and L<sub>c</sub> = 15nm. The results are shown in Fig.4. The experimental value of  $\alpha = 0.3 - 0.5$  agrees well again with the exponential autocorrelation.



Fig.4 Width of interfaces generated by simulation.

## 4. SUMMARY

In summary, the width of the  $\text{SiO}_2/\text{Si}$ interface increased as a power of the scale up to 100nm with  $\alpha = 0.3 - 0.5$ , and saturated at *ca*. 0.3nm above 100nm scale. The scaling behavior was well described by an exponential autocorrelation function with the correlation length of *ca*. 15nm.

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